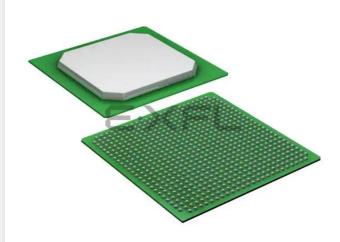
# E·XFL

# Intel - 5CGXFC4C6F27C6N Datasheet



Welcome to <u>E-XFL.COM</u>

#### Understanding <u>Embedded - FPGAs (Field</u> <u>Programmable Gate Array)</u>

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

#### **Applications of Embedded - FPGAs**

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

#### Details

Detuils	
Product Status	Active
Number of LABs/CLBs	18868
Number of Logic Elements/Cells	50000
Total RAM Bits	2862080
Number of I/O	336
Number of Gates	-
Voltage - Supply	1.07V ~ 1.13V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	672-BGA
Supplier Device Package	672-FBGA (27x27)
Purchase URL	https://www.e-xfl.com/product-detail/intel/5cgxfc4c6f27c6n

Email: info@E-XFL.COM

Address: Room A, 16/F, Full Win Commercial Centre, 573 Nathan Road, Mongkok, Hong Kong



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# **Summary of Cyclone V Features**

# Table 2. Summary of Features for Cyclone V Devices

Feature		Description						
Technology	<ul><li>TSMC's 28-nm low-p</li><li>1.1 V core voltage</li></ul>	······································						
Packaging	<ul> <li>Multiple device densi different device dens</li> </ul>	Wirebond low-halogen packages Multiple device densities with compatible package footprints for seamless migration between different device densities RoHS-compliant and leaded <sup>(1)</sup> options						
High-performance FPGA fabric	Enhanced 8-input ALM w	nhanced 8-input ALM with four registers						
Internal memory blocks		b) memory blocks with soft error correction code (ECC) block (MLAB)—640-bit distributed LUTRAM where you can use up to 25% memory						
Embedded Hard IP blocks	Variable-precision DSP	<ul> <li>Native support for up to three signal processing precision levels (three 9 x 9, two 18 x 18, or one 27 x 27 multiplier) in the same variable-precision DSP block</li> <li>64-bit accumulator and cascade</li> <li>Embedded internal coefficient memory</li> <li>Preadder/subtractor for improved efficiency</li> </ul>						
	Memory controller	DDR3, DDR2, and LPDDR2 with 16 and 32 bit ECC support						
	Embedded transceiver I/OPCI Express* (PCIe*) Gen2 and Gen1 (x1, x2, or x4) hard IP with multifunction support, endpoint, and root port							
Clock networks	, , , ,	l clock network d peripheral clock networks are not used can be powered down to reduce dynamic power						
Phase-locked loops (PLLs)	<ul><li> Precision clock synth</li><li> Integer mode and fra</li></ul>	esis, clock delay compensation, and zero delay buffering (ZDB) actional mode						
FPGA General-purpose I/Os (GPIOs)	<ul><li>400 MHz/800 Mbps e</li><li>On-chip termination</li></ul>	cond (Mbps) LVDS receiver and 840 Mbps LVDS transmitter external memory interface (OCT) p to 16 mA drive strength						
Low-power high-speed serial interface	<ul> <li>614 Mbps to 6.144 Gbps integrated transceiver speed</li> <li>Transmit pre-emphasis and receiver equalization</li> <li>Dynamic partial reconfiguration of individual channels</li> </ul>							
HPS (Cyclone V SE, SX, and ST devices only)	<ul> <li>Single or dual-core Arm Cortex-A9 MPCore processor-up to 925 MHz maximum frequency support for symmetric and asymmetric multiprocessing</li> <li>Interface peripherals—10/100/1000 Ethernet media access control (EMAC), USB 2.0 On-The-GO (OTG) controller, quad serial peripheral interface (QSPI) flash controller, NAN flash controller, Secure Digital/MultiMediaCard (SD/MMC) controller, UART, controller area network (CAN), serial peripheral interface (SPI), I<sup>2</sup>C interface, and up to 85 HPS GPIO interfaces</li> </ul>							
		-general-purpose timers, watchdog timers, direct memory access (DMA) iguration manager, and clock and reset managers						
		continued						

<sup>&</sup>lt;sup>(1)</sup> Contact Intel for availability.



Feature	Description
	<ul> <li>HPS-FPGA bridges—include the FPGA-to-HPS, HPS-to-FPGA, and lightweight HPS-to-FPGA bridges that allow the FPGA fabric to issue transactions to slaves in the HPS, and vice versa</li> <li>FPGA-to-HPS SDRAM controller subsystem—provides a configurable interface to the multiport front end (MPFE) of the HPS SDRAM controller</li> <li>Arm CoreSight<sup>™</sup> JTAG debug access port, trace port, and on-chip trace storage</li> </ul>
Configuration	<ul> <li>Tamper protection—comprehensive design protection to protect your valuable IP investments</li> <li>Enhanced advanced encryption standard (AES) design security features</li> <li>CvP</li> <li>Dynamic reconfiguration of the FPGA</li> <li>Active serial (AS) x1 and x4, passive serial (PS), JTAG, and fast passive parallel (FPP) x8 and x16 configuration options</li> <li>Internal scrubbing <sup>(2)</sup></li> <li>Partial reconfiguration <sup>(3)</sup></li> </ul>

# **Cyclone V Device Variants and Packages**

## Table 3. Device Variants for the Cyclone V Device Family

Variant	Description
Cyclone V E	Optimized for the lowest system cost and power requirement for a wide spectrum of general logic and DSP applications
Cyclone V GX	Optimized for the lowest cost and power requirement for 614 Mbps to 3.125 Gbps transceiver applications
Cyclone V GT	The FPGA industry's lowest cost and lowest power requirement for 6.144 Gbps transceiver applications
Cyclone V SE	SoC with integrated Arm-based HPS
Cyclone V SX	SoC with integrated Arm-based HPS and 3.125 Gbps transceivers
Cyclone V ST	SoC with integrated Arm-based HPS and 6.144 Gbps transceivers

# Cyclone V E

This section provides the available options, maximum resource counts, and package plan for the Cyclone V E devices.

The information in this section is correct at the time of publication. For the latest information and to get more details, refer to the Product Selector Guide.

#### **Related Information**

#### Product Selector Guide

Provides the latest information about Intel products.

<sup>(2)</sup> The SEU internal scrubbing feature is available for Cyclone V E, GX, SE, and SX devices with the "SC" suffix in the part number. For device availability and ordering, contact your local Intel sales representatives.

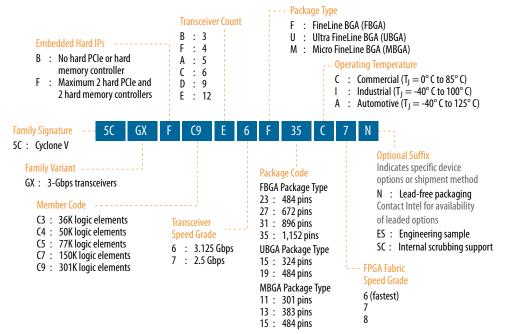
<sup>(3)</sup> The partial reconfiguration feature is available for Cyclone V E, GX, SE, and SX devices with the "SC" suffix in the part number. For device availability and ordering, contact your local Intel<sup>®</sup> sales representatives.



# **Available Options**

#### Figure 2. Sample Ordering Code and Available Options for Cyclone V GX Devices

The SEU internal scrubbing feature is available for Cyclone V E, GX, SE, and SX devices with the "SC" suffix in the part number. For device availability and ordering, contact your local Intel sales representatives.



# **Maximum Resources**

## Table 6. Maximum Resource Counts for Cyclone V GX Devices

Reso	ource		Member Code					
		C3	C4	C5	C7	C9		
Logic Elements	(LE) (K)	36	50	77	150	301		
ALM		13,460	18,860	29,080	56,480	113,560		
Register		53,840	75,440	116,320	225,920	454,240		
Memory (Kb)	M10K	1,350	2,500	4,460	6,860	12,200		
	MLAB	182	424	424	836	1,717		
Variable-precisio	on DSP Block	57	70	150	156	342		
18 x 18 Multiplie	er	114	140	300	312	684		
PLL	PLL		6	6	7	8		
3 Gbps Transceiver		3	6	6	9	12		
GPIO <sup>(4)</sup>		208	336	336	480	560		
		•	1	1	1	continued		

<sup>&</sup>lt;sup>(4)</sup> The number of GPIOs does not include transceiver I/Os. In the Intel Quartus<sup>®</sup> Prime software, the number of user I/Os includes transceiver I/Os.



Resource		Member Code				
		D5	D7	D9		
	Receiver	84	120	140		
PCIe Hard IP Block		2	2	2		
Hard Memory Controller		2	2	2		

## **Related Information**

# True LVDS Buffers in Devices, I/O Features in Cyclone V Devices

Provides the number of LVDS channels in each device package.

# **Package Plan**

#### Table 9.Package Plan for Cyclone V GT Devices

Transceiver counts shown are for transceiver  $\leq 5$  Gbps . 6 Gbps transceiver channel count support depends on the package and channel usage. For more information about the 6 Gbps transceiver channel count, refer to the *Cyclone V Device Handbook Volume 2: Transceivers*.

Member Code	M3 (11 )		M3 (13 i		M4 (15 i		U4 (19 ו	
	GPIO	XCVR	GPIO	XCVR	GPIO	XCVR	GPIO	XCVR
D5	129	4	175	6	_	_	224	6
D7	_	_	_	_	240	3	240	6
D9	_	—	—	_	—		240	5

Member Code		F484 (23 mm)		72 mm)	F8 (31	96 mm)	F11 (35 i	
	GPIO	XCVR	GPIO	XCVR	GPIO	XCVR	GPIO	XCVR
D5	240	6	336	6	_	_	_	_
D7	240	6	336	9 ( <del>6</del> )	480	9 ( <del>6</del> )	—	—
D9	224	6	336	9 ( <del>6</del> )	480	12 (7)	560	12 (7)

#### **Related Information**

6.144-Gbps Support Capability in Cyclone V GT Devices, Cyclone V Device Handbook Volume 2: Transceivers

Provides more information about 6 Gbps transceiver channel count.

<sup>(6)</sup> If you require CPRI (at 6.144 Gbps) and PCIe Gen2 transmit jitter compliance, Intel recommends that you use only up to three full-duplex transceiver channels for CPRI, and up to six full-duplex channels for PCIe Gen2. The CMU channels are not considered full-duplex channels.

<sup>(7)</sup> If you require CPRI (at 6.144 Gbps) and PCIe Gen2 transmit jitter compliance, Intel recommends that you use only up to three full-duplex transceiver channels for CPRI, and up to eight full-duplex channels for PCIe Gen2. The CMU channels are not considered full-duplex channels.



# **Cyclone V SE**

This section provides the available options, maximum resource counts, and package plan for the Cyclone V SE devices.

The information in this section is correct at the time of publication. For the latest information and to get more details, refer to the *Product Selector Guide*.

#### **Related Information**

#### Product Selector Guide

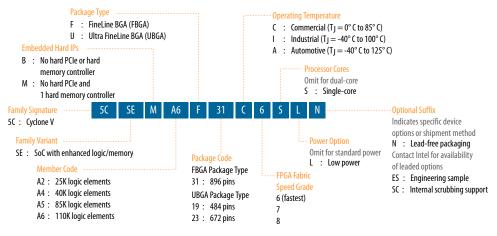
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## **Available Options**

#### Figure 4. Sample Ordering Code and Available Options for Cyclone V SE Devices

The SEU internal scrubbing feature is available for Cyclone V E, GX, SE, and SX devices with the "SC" suffix in the part number. For device availability and ordering, contact your local Intel sales representatives.

Cyclone V SE and SX low-power devices (L power option) offer 30% static power reduction for devices with 25K LE and 40K LE, and 20% static power reduction for devices with 85K LE and 110K LE.





# **Maximum Resources**

#### Table 10. Maximum Resource Counts for Cyclone V SE Devices

Res	ource		Ме	mber Code	
		A2	A4	A5	A6
Logic Elements (LE) (K)		25	40	85	110
ALM		9,430	15,880	32,070	41,910
Register		37,736	60,376	128,300	166,036
Memory (Kb)	M10K	1,400	2,700	3,970	5,570
	MLAB	138	231	480	621
Variable-precisio	n DSP Block	36	84	87	112
18 x 18 Multiplie	18 x 18 Multiplier		168	174	224
FPGA PLL		5	5	6	6
HPS PLL		3	3	3	3
FPGA GPIO		145	145	288	288
HPS I/O		181	181	181	181
LVDS	Transmitter	32	32	72	72
	Receiver	37	37	72	72
FPGA Hard Memo	ory Controller	1	1	1	1
HPS Hard Memor	y Controller	1	1	1	1
Arm Cortex-A9 M	IPCore Processor	Single- or dual- core	Single- or dual- core	Single- or dual-core	Single- or dual-core

## **Related Information**

True LVDS Buffers in Devices, I/O Features in Cyclone V Devices Provides the number of LVDS channels in each device package.

# **Package Plan**

### Table 11.Package Plan for Cyclone V SE Devices

The HPS I/O counts are the number of I/Os in the HPS and does not correlate with the number of HPS-specific I/O pins in the FPGA. Each HPS-specific pin in the FPGA may be mapped to several HPS I/Os.

Member Code	U484 (19 mm)				F896 (31 mm)	
	FPGA GPIO	HPS I/O	FPGA GPIO	HPS I/O	FPGA GPIO	HPS I/O
A2	66	151	145	181	_	_
A4	66	151	145	181	_	_
A5	66	151	145	181	288	181
A6	66	151	145	181	288	181

#### Cyclone V Device Overview CV-51001 | 2018.05.07



F	Resource		Membe	r Code	
		C2	C4	C5	C6
HPS PLL		3	3	3	3
3 Gbps Transce	iver	6	6	9	9
FPGA GPIO <sup>(8)</sup>		145	145	288	288
HPS I/O		181	181	181	181
LVDS	Transmitter	32	32	72	72
	Receiver	37	37	72	72
PCIe Hard IP Bl	lock	2	2	2 <sup>(9)</sup>	2 (9)
FPGA Hard Memory Controller		1	1	1	1
HPS Hard Memory Controller		1	1	1	1
Arm Cortex-A9	MPCore Processor	Dual-core	Dual-core	Dual-core	Dual-core

#### **Related Information**

True LVDS Buffers in Devices, I/O Features in Cyclone V Devices Provides the number of LVDS channels in each device package.

# **Package Plan**

## Table 13.Package Plan for Cyclone V SX Devices

The HPS I/O counts are the number of I/Os in the HPS and does not correlate with the number of HPS-specific I/O pins in the FPGA. Each HPS-specific pin in the FPGA may be mapped to several HPS I/Os.

Member Code		U672 (23 mm)		F896 (31 mm)		
	FPGA GPIO	HPS I/O	XCVR	FPGA GPIO	HPS I/O	XCVR
C2	145	181	6	_	_	_
C4	145	181	6	_	-	_
C5	145	181	6	288	181	9
C6	145	181	6	288	181	9

# **Cyclone V ST**

This section provides the available options, maximum resource counts, and package plan for the Cyclone V ST devices.

The information in this section is correct at the time of publication. For the latest information and to get more details, refer to the *Product Selector Guide*.

<sup>&</sup>lt;sup>(8)</sup> The number of GPIOs does not include transceiver I/Os. In the Intel Quartus Prime software, the number of user I/Os includes transceiver I/Os.

<sup>&</sup>lt;sup>(9)</sup> 1 PCIe Hard IP Block in U672 package.



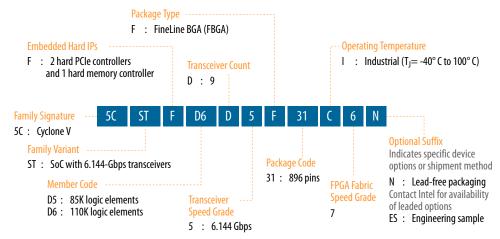
## **Related Information**

Product Selector Guide

Provides the latest information about Intel products.

# **Available Options**

## Figure 6. Sample Ordering Code and Available Options for Cyclone V ST Devices



# **Maximum Resources**

## Table 14. Maximum Resource Counts for Cyclone V ST Devices

Res	ource	Member	r Code
		D5	D6
Logic Elements (LE) (K)		85	110
ALM		32,070	41,910
Register		128,300	166,036
Memory (Kb)	M10K	3,970	5,570
	MLAB	480	621
Variable-precision DSP Block		87	112
18 x 18 Multiplier		174	224
FPGA PLL		6	6
HPS PLL		3	3
6.144 Gbps Transceiver	4 Gbps Transceiver		9
FPGA GPIO <sup>(10)</sup>	A GPIO <sup>(10)</sup>		288
HPS I/O		181	181
LVDS	Transmitter	72	72
			continued

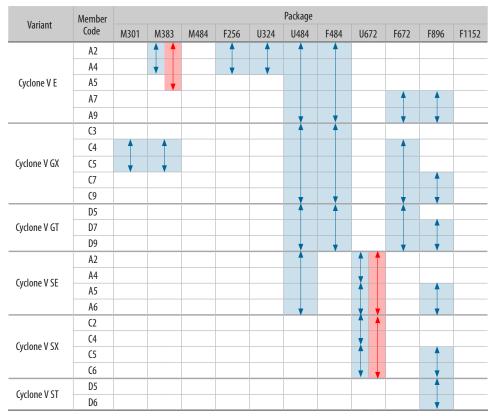
<sup>&</sup>lt;sup>(10)</sup> The number of GPIOs does not include transceiver I/Os. In the Intel Quartus Prime software, the number of user I/Os includes transceiver I/Os.



# **I/O Vertical Migration for Cyclone V Devices**

## Figure 7. Vertical Migration Capability Across Cyclone V Device Packages and Densities

The arrows indicate the vertical migration paths. The devices included in each vertical migration path are shaded. You can also migrate your design across device densities in the same package option if the devices have the same dedicated pins, configuration pins, and power pins.



You can achieve the vertical migration shaded in red if you use only up to 175 GPIOs for the M383 package, and 138 GPIOs for the U672 package. These migration paths are not shown in the Intel Quartus Prime software Pin Migration View.

*Note:* To verify the pin migration compatibility, use the Pin Migration View window in the Intel Quartus Prime software Pin Planner.

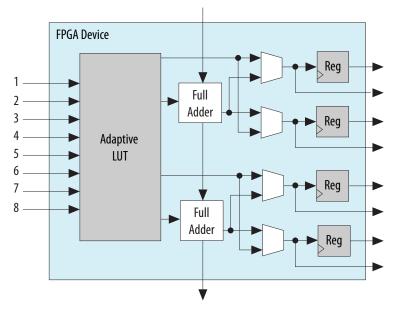
# **Adaptive Logic Module**

Cyclone V devices use a 28 nm ALM as the basic building block of the logic fabric.

The ALM, as shown in following figure, uses an 8-input fracturable look-up table (LUT) with four dedicated registers to help improve timing closure in register-rich designs and achieve an even higher design packing capability than previous generations.



#### Figure 8. ALM for Cyclone V Devices



You can configure up to 25% of the ALMs in the Cyclone V devices as distributed memory using MLABs.

#### **Related Information**

Embedded Memory Capacity in Cyclone V Devices on page 21 Lists the embedded memory capacity for each device.

# **Variable-Precision DSP Block**

Cyclone V devices feature a variable-precision DSP block that supports these features:

- Configurable to support signal processing precisions ranging from 9 x 9, 18 x 18 and 27 x 27 bits natively
- A 64-bit accumulator
- A hard preadder that is available in both 18- and 27-bit modes
- Cascaded output adders for efficient systolic finite impulse response (FIR) filters
- Internal coefficient register banks, 8 deep, for each multiplier in 18- or 27-bit mode
- Fully independent multiplier operation
- A second accumulator feedback register to accommodate complex multiplyaccumulate functions
- Fully independent Efficient support for single-precision floating point arithmetic
- The inferability of all modes by the Intel Quartus Prime design software



## Table 16. Variable-Precision DSP Block Configurations for Cyclone V Devices

Usage Example	Multiplier Size (Bit)	DSP Block Resource
Low precision fixed point for video applications	Three 9 x 9	1
Medium precision fixed point in FIR filters	Two 18 x 18	1
FIR filters and general DSP usage	Two 18 x 18 with accumulate	1
High precision fixed- or floating-point implementations	One 27 x 27 with accumulate	1

You can configure each DSP block during compilation as independent three 9 x 9, two  $18 \times 18$ , or one  $27 \times 27$  multipliers. With a dedicated 64 bit cascade bus, you can cascade multiple variable-precision DSP blocks to implement even higher precision DSP functions efficiently.

#### Table 17. Number of Multipliers in Cyclone V Devices

The table lists the variable-precision DSP resources by bit precision for each Cyclone V device.

Variant	Member Code	Variable- precision DSP Block		dent Input an plications Ope		18 x 18 Multiplier	18 x 18 Multiplier Adder Summed with 36 bit Input
		DSP Block	9 x 9 Multiplier	18 x 18 Multiplier	27 x 27 Multiplier	Adder Mode	
Cyclone V E	A2	25	75	50	25	25	25
	A4	66	198	132	66	66	66
-	A5	150	450	300	150	150	150
	A7	156	468	312	156	156	156
	A9	342	1,026	684	342	342	342
Cyclone V	C3	57	171	114	57	57	57
GX	C4	70	210	140	70	70	70
-	C5	150	450	300	150	150	150
	C7	156	468	312	156	156	156
-	C9	342	1,026	684	342	342	342
Cyclone V GT	D5	150	450	300	150	150	150
	D7	156	468	312	156	156	156
-	D9	342	1,026	684	342	342	342
Cyclone V SE	A2	36	108	72	36	36	36
-	A4	84	252	168	84	84	84
	A5	87	261	174	87	87	87
	A6	112	336	224	112	112	112
Cyclone V SX	C2	36	108	72	36	36	36
	C4	84	252	168	84	84	84
	C5	87	261	174	87	87	87
							continued



	Member	M10K		ML	Total RAM Bit	
Variant	Code	Block	RAM Bit (Kb)	Block	RAM Bit (Kb)	(Kb)
Cyclone V GT	D5	446	4,460	679	424	4,884
	D7	686	6,860	1338	836	7,696
	D9	1,220	12,200	2748	1,717	13,917
Cyclone V SE	A2	140	1,400	221	138	1,538
	A4	270	2,700	370	231	2,460
	A5	397	3,970	768	480	4,450
	A6	553	5,530	994	621	6,151
Cyclone V SX	C2	140	1,400	221	138	1,538
	C4	270	2,700	370	231	2,460
	C5	397	3,970	768	480	4,450
	C6	553	5,530	994	621	6,151
Cyclone V ST	D5	397	3,970	768	480	4,450
	D6	553	5,530	994	621	6,151

# **Embedded Memory Configurations**

# Table 19. Supported Embedded Memory Block Configurations for Cyclone V Devices

This table lists the maximum configurations supported for the embedded memory blocks. The information is applicable only to the single-port RAM and ROM modes.

Memory Block	Depth (bits)	Programmable Width
MLAB	32	x16, x18, or x20
M10K	256	x40 or x32
	512	x20 or x16
	1К	x10 or x8
	2К	x5 or x4
	4К	x2
	8К	×1

# **Clock Networks and PLL Clock Sources**

550 MHz Cyclone V devices have 16 global clock networks capable of up to operation. The clock network architecture is based on Intel's global, quadrant, and peripheral clock structure. This clock structure is supported by dedicated clock input pins and fractional PLLs.

*Note:* To reduce power consumption, the Intel Quartus Prime software identifies all unused sections of the clock network and powers them down.



# **PLL Features**

The PLLs in the Cyclone V devices support the following features:

- Frequency synthesis
- On-chip clock deskew
- Jitter attenuation
- Programmable output clock duty cycles
- PLL cascading
- Reference clock switchover
- Programmable bandwidth
- User-mode reconfiguration of PLLs
- Low power mode for each fractional PLL
- Dynamic phase shift
- Direct, source synchronous, zero delay buffer, external feedback, and LVDS compensation modes

#### **Fractional PLL**

In addition to integer PLLs, the Cyclone V devices use a fractional PLL architecture. The devices have up to eight PLLs, each with nine output counters. You can use the output counters to reduce PLL usage in two ways:

- Reduce the number of oscillators that are required on your board by using fractional PLLs
- Reduce the number of clock pins that are used in the device by synthesizing multiple clock frequencies from a single reference clock source

If you use the fractional PLL mode, you can use the PLLs for precision fractional-N frequency synthesis—removing the need for off-chip reference clock sources in your design.

The transceiver fractional PLLs that are not used by the transceiver I/Os can be used as general purpose fractional PLLs by the FPGA fabric.

# **FPGA General Purpose I/O**

Cyclone V devices offer highly configurable GPIOs. The following list describes the features of the GPIOs:

- Programmable bus hold and weak pull-up
- LVDS output buffer with programmable differential output voltage (V\_{\text{OD}}) and programmable pre-emphasis
- On-chip parallel termination ( $R_T$  OCT) for all I/O banks with OCT calibration to limit the termination impedance variation
- On-chip dynamic termination that has the ability to swap between series and parallel termination, depending on whether there is read or write on a common bus for signal integrity
- Easy timing closure support using the hard read FIFO in the input register path, and delay-locked loop (DLL) delay chain with fine and coarse architecture



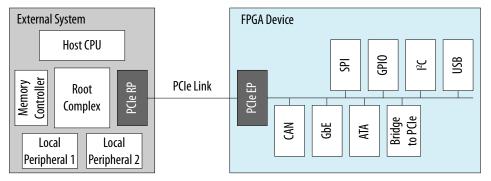
# PCIe Gen1 and Gen2 Hard IP

Cyclone V GX, GT, SX, and ST devices contain PCIe hard IP that is designed for performance and ease-of-use. The PCIe hard IP consists of the MAC, data link, and transaction layers.

The PCIe hard IP supports PCIe Gen2 and Gen1 end point and root port for up to x4 lane configuration. The PCIe Gen2 x4 support is PCIe-compatible.

The PCIe endpoint support includes multifunction support for up to eight functions, as shown in the following figure. The integrated multifunction support reduces the FPGA logic requirements by up to 20,000 LEs for PCIe designs that require multiple peripherals.

#### Figure 9. PCIe Multifunction for Cyclone V Devices



The Cyclone V PCIe hard IP operates independently from the core logic. This independent operation allows the PCIe link to wake up and complete link training in less than 100 ms while the Cyclone V device completes loading the programming file for the rest of the device.

In addition, the PCIe hard IP in the Cyclone V device provides improved end-to-end datapath protection using ECC.

# **External Memory Interface**

This section provides an overview of the external memory interface in Cyclone V devices.

# Hard and Soft Memory Controllers

Cyclone V devices support up to two hard memory controllers for DDR3, DDR2, and LPDDR2 SDRAM devices. Each controller supports 8 to 32 bit components of up to 4 gigabits (Gb) in density with two chip selects and optional ECC. For the Cyclone V SoC devices, an additional hard memory controller in the HPS supports DDR3, DDR2, and LPDDR2 SDRAM devices.

All Cyclone V devices support soft memory controllers for DDR3, DDR2, and LPDDR2 SDRAM devices for maximum flexibility.



*Note:* Although the FPGA fabric and HPS are on separate power domains, the HPS must remain powered up during operation while the FPGA fabric can be powered up or down as required.

#### **Related Information**

Cyclone V Device Family Pin Connection Guidelines

Provides detailed information about power supply pin connection guidelines and power regulator sharing.

## **Hardware and Software Development**

For hardware development, you can configure the HPS and connect your soft logic in the FPGA fabric to the HPS interfaces using the Platform Designer (Standard) system integration tool in the Intel Quartus Prime software.

For software development, the Arm-based SoC devices inherit the rich software development ecosystem available for the Arm Cortex-A9 MPCore processor. The software development process for Intel SoCs follows the same steps as those for other SoC devices from other manufacturers. Support for Linux, VxWorks<sup>®</sup>, and other operating systems is available for the SoCs. For more information on the operating systems support availability, contact the Intel sales team.

You can begin device-specific firmware and software development on the Intel SoC Virtual Target. The Virtual Target is a fast PC-based functional simulation of a target development system—a model of a complete development board that runs on a PC. The Virtual Target enables the development of device-specific production software that can run unmodified on actual hardware.

#### **Related Information**

International Altera Sales Support Offices

# **Dynamic and Partial Reconfiguration**

The Cyclone V devices support dynamic reconfiguration and partial reconfiguration.

# **Dynamic Reconfiguration**

The dynamic reconfiguration feature allows you to dynamically change the transceiver data rates, PMA settings, or protocols of a channel, without affecting data transfer on adjacent channels. This feature is ideal for applications that require on-the-fly multiprotocol or multirate support. You can reconfigure the PMA and PCS blocks with dynamic reconfiguration.

# **Partial Reconfiguration**

*Note:* The partial reconfiguration feature is available for Cyclone V E, GX, SE, and SX devices with the "SC" suffix in the part number. For device availability and ordering, contact your local Intel sales representatives.

Partial reconfiguration allows you to reconfigure part of the device while other sections of the device remain operational. This capability is important in systems with critical uptime requirements because it allows you to make updates or adjust functionality without disrupting services.



Apart from lowering cost and power consumption, partial reconfiguration increases the effective logic density of the device because placing device functions that do not operate simultaneously is not necessary. Instead, you can store these functions in external memory and load them whenever the functions are required. This capability reduces the size of the device because it allows multiple applications on a single device—saving the board space and reducing the power consumption.

Intel simplifies the time-intensive task of partial reconfiguration by building this capability on top of the proven incremental compile and design flow in the Intel Quartus Prime design software. With the Intel solution, you do not need to know all the intricate device architecture details to perform a partial reconfiguration.

Partial reconfiguration is supported through the FPP x16 configuration interface. You can seamlessly use partial reconfiguration in tandem with dynamic reconfiguration to enable simultaneous partial reconfiguration of both the device core and transceivers.

# **Enhanced Configuration and Configuration via Protocol**

Cyclone V devices support 1.8 V, 2.5 V, 3.0 V, and 3.3 V programming voltages and several configuration schemes.

Mode	Data Width	Max Clock Rate (MHz)	Max Data Rate (Mbps)	Decompressi on	Design Security	Partial Reconfigurat ion <sup>(18)</sup>	Remote System Update
AS through the EPCS and EPCQ serial configuration device	1 bit, 4 bits	100	_	Yes	Yes	_	Yes
PS through CPLD or external microcontroller	1 bit	125	125	Yes	Yes	_	_
FPP	8 bits	125	_	Yes	Yes	_	Parallel flash
	16 bits	125	_	Yes	Yes	Yes	loader
CvP (PCIe)	x1, x2, and x4 lanes	-	_	Yes	Yes	Yes	_
JTAG	1 bit	33	33	-	_	_	_

 Table 24.
 Configuration Schemes and Features Supported by Cyclone V Devices

Instead of using an external flash or ROM, you can configure the Cyclone V devices through PCIe using CvP. The CvP mode offers the fastest configuration rate and flexibility with the easy-to-use PCIe hard IP block interface. The Cyclone V CvP implementation conforms to the PCIe 100 ms power-up-to-active time requirement.

# **Related Information**

Configuration via Protocol (CvP) Implementation in Intel FPGAs User Guide Provides more information about CvP.

<sup>&</sup>lt;sup>(18)</sup> The partial reconfiguration feature is available for Cyclone V E, GX, SE, and SX devices with the "SC" suffix in the part number. For device availability and ordering, contact your local Intel sales representatives.

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Date	Version	Changes
		<ul> <li>Updated MLAB RAM Bit (Kb) in Embedded Memory Capacity and Distribution in Cyclone V Devices table as follows:</li> <li>Cyclone V GX C3: Updated from 181 to 182</li> <li>Cyclone V GX C4: Updated from 295 to 424</li> <li>Updated Total RAM Bit (Kb) in Embedded Memory Capacity and Distribution in Cyclone V Devices table as follows:</li> <li>Cyclone V GX C3: Updated from 1,531 to 1,532</li> <li>Cyclone V GX C4: Updated from 2,795 to 2,924</li> <li>Updated MLAB Block count in Embedded Memory Capacity and Distribution in Cyclone V Devices table as follows:</li> <li>Cyclone V GX C4: Updated from 2,795 to 2,924</li> <li>Updated MLAB Block count in Embedded Memory Capacity and Distribution in Cyclone V Devices table as follows:</li> <li>Cyclone V GX C4: Updated from 472 to 678</li> <li>Cyclone V GX C5: Updated from 679 to 678</li> </ul>
March 2015	2015.03.31	<ul> <li>Added internal scrubbing feature under configuration in Summary of Features for Cyclone V Devices table.</li> <li>Added optional suffix "SC: Internal scrubbing support" to the following diagrams: <ul> <li>Sample Ordering Code and Available Options for Cyclone V E Devices</li> <li>Sample Ordering Code and Available Options for Cyclone V GX Devices</li> <li>Sample Ordering Code and Available Options for Cyclone V SE Devices</li> <li>Sample Ordering Code and Available Options for Cyclone V SE Devices</li> </ul> </li> </ul>
January 2015	2015.01.23	<ul> <li>Updated Sample Ordering Code and Available Options for Cyclone V ST Devices figure because Cyclone V ST devices are only available in I temperature grade and -7 speed grade.</li> <li>Operating Temperature: Removed C and A temperature grades</li> <li>FPGA Fabric Speed Grade: Removed -6 and -8 speed grades</li> <li>Updated the transceiver specification for Cyclone V ST from 5 Gbps to 6.144 Gbps:         <ul> <li>Device Variants for the Cyclone V Device Family table</li> <li>Sample Ordering Code and Available Options for Cyclone V ST Devices figure</li> <li>Maximum Resource Counts for Cyclone V ST Devices</li> <li>Updated Maximum Resource Counts for Cyclone V GX Devices table for Cyclone V GX G3 devices.</li> <li>Logic elements (LE) (K): Updated from 35.7 to 35.5</li> <li>Variable-precision DSP block: Updated from 51 to 57</li> <li>18 x 18 multiplier: Updated from 102 to 114</li> </ul> </li> <li>Updated Number of Multipliers in Cyclone V Devices table for Cyclone V GX G3 devices.</li> <ul> <li>Variableprecision DSP Block: Updated from 51 to 57</li> <li>9 x 9 Multiplier: Updated from 102 to 114</li> </ul> <li>Updated Number of Multipliers in Cyclone V Devices table for Cyclone V GX G3 devices.</li> <ul> <li>Variableprecision DSP Block: Updated from 51 to 57</li> <li>9 x 9 Multiplier: Updated from 102 to 114</li> </ul> <li>Updated Rumory Capacity and Distribution in Cyclone V Devices table for Cyclone V GX G3 devices.</li> <ul> <li>Multiplier Adder Mode: Updated from 51 to 57</li> <li>18 x 18 Multiplier Adder Summed with 36 bit Input: Updated from 51 to 57</li> <li>18 x 18 Multiplier Adder Summed with 36 bit Input: Updated from 51 to 57</li> <li>M10K RAM bit (Kb): Updated from 1,190 to 1,350</li> <li>MLAB Block: Updated from 125 to 291</li> <ul> <li>MLAB RAM b</li></ul></ul></ul>
October 2014	2014.10.06	Added a footnote to the "Transceiver PCS Features for Cyclone V Devices"
		table to show that PCIe Gen2 is supported for Cyclone V GT and ST devices. continued

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Cyclone V SE and SX devices.           December 2013         2013.12.26         Corrected single or dual-core ARM Cortex-A9 MPCore processor-up to 925 Mitz from 800 Mitz.           Removed "Preliminary" texts from Ordering Code figures, Maximum Resources, Package Plan and I/O Vertical Migration tables.         Removed the note "The number of GPIOs does not include transceiver I/Os. In the Quartus II software, the number of user I/Os includes transceiver I/Os. In the Maximum Resources Counts table for Cyclone V E and SE.           Added leaded package options.         Removed the note "The number of PLLs includes guerant.           Updated Timbedded Hard IPs for Cyclone V GT devices to indicate Maximum 2 hard PCIe and 2 hard memory controllers.         Addeel deaded package options.           Removed the note "The number of PLLs includes gueran-purpose fractional PLLs and transceiver fractional PLLs." for all PLLs in the Maximum Resource Counts table.         Corrected max LVDS counts for transmitter and receiver for Cyclone V E A5 device from 34 to 50.           Corrected variable-precision DSP block, 27 x 27 multiplier, 18 x 18 multiplier adder summed with 36 bit input for Cyclone V SE devices from 116 to 150.         Corrected VAS and VAS are validated and VA as well as SX C2 and C4 devices from 35 to 32.           Corrected VDS transmitter for Cyclone V SE A2 and A4 as well as SX C2 and C4 devices from 35 to 32.         Corrected VAS from 35 to 32.           Corrected VADI is supported through the soft PCS in the PCS features for Cyclone V SE A2 and A4 as well as SX C2 and C4 devices from 35 to 32.         Corrected VADI is supported through the soft PCS in the PCS features for Cyclone V SE A2 and A4 a	Date	Version	Changes
MHz from 800 MHz.         Removed "Preliminary" texts from Ordering Code figures, Maximum Resources, Package Plan and I/O Vertical Migration tables.         Removed the note "The number of GPI05 does not include transceiver I/Os. In the Quartus II software, the number of user /Os includes transceiver I/Os. The GPI05 in the Maximum Resource Counts table for Cyclone V E and SE.         • Added limk to Altera Product Selector for each device variant.         • Updated Embedded Hard IPs for Cyclone V GT devices to indicate Maximum 2 hard PCI2 and 2 hard memory controllers.         • Added leaded package options.         • Removed the note. "The number of PLLs includes general-purpose fractional PLLs and transceiver fractional PLLs." for all PLLs in the Maximum Resource Counts table.         • Corrected max LVDS counts for transmitter and receiver for Cyclone V E AS device from 14 to 120.         • Corrected max LVDS counts for transmitter and receiver for Cyclone V E AS devices from 31 to 120.         • Corrected 18 x 18 multiplier of Cyclone V SE devices from 116 to 168.         • Corrected 1VDS transmitter for Cyclone V SE A2 and A4 as well as SX C2 and C4 devices from 31 to 32.         • Corrected 1VDS reavers for Cyclone V SE A2 and A4 as well as SX C2 and C4 devices from 31 to 32.         • Corrected 1VDS reavers from May Cycle SE A3 and A4 as well as SX C2 and C4 devices from 31 to 32.         • Corrected AVLDI is supported through the soft PCS in the PCS features for Cyclone V.         • Added the DDR3 SDRAM for the maximum frequency's soft controller and the minimum frequency from 300 to 330 for vollege 1.35V.	July 2014	2014.07.07	Updated the I/O vertical migration figure to clarify the migration capability of Cyclone V SE and SX devices.
<ul> <li>Corrected 18 x 18 multiplier for Cyclone V SE devices from 116 to 168.</li> <li>Corrected 9 x 9 multiplier for Cyclone V SE devices from 174 to 252.</li> <li>Corrected LVDS transmitter for Cyclone V SE A2 and A4 as well as SX C2 and C4 devices from 31 to 32.</li> <li>Corrected LVDS receiver for Cyclone V SE A2 and A4 as well as SX C2 and C4 devices from 35 to 37.</li> <li>Corrected transceiver speed grade for Cyclone V ST devices ordering code from 4 to 5.</li> <li>Updated the DDR3 SDRAM for the maximum frequency's soft controller and the minimum frequency from 300 to 303 for voltage 1.35V.</li> <li>Added links to Altera's External Memory Spec Estimator tool to the topics listing the external memory interface performance.</li> <li>Corrected XAUI is supported through the soft PCS in the PCS features for Cyclone V.</li> <li>Added links to the known document issues in the Knowledge Base.</li> <li>Moved all links to the Related Information section of respective topics for easy reference.</li> <li>Corrected the Supporting Feature in Table 1 of Increased bandwidth capacity to '6.144 Gbps'.</li> <li>Updated Description in Table 2 of Low-power high-speed serial interface to '6.144 Gbps'.</li> <li>Updated Description in Table 3 of Cyclone V GT to '6.144 Gbps'.</li> <li>Updated LVDS in the Maximum Resource Counts tables to include Transmitter and Receiver values.</li> <li>Updated LVDS in the Maximum Resource Counts tables to include Transmitter and Receiver values.</li> <li>Updated He package plan with M383 for the Cyclone V E device.</li> <li>Removed the M301 and M383 packages from the Cyclone V GX C4 device</li> <li>Updated the GPI0 count to '129' for the M301 package of the Cyclone V</li> </ul>	December 2013	2013.12.26	<ul> <li>Corrected single or dual-core ARM Cortex-A9 MPCore processor-up to 925 MHz from 800 MHz.</li> <li>Removed "Preliminary" texts from Ordering Code figures, Maximum Resources, Package Plan and I/O Vertical Migration tables.</li> <li>Removed the note "The number of GPIOs does not include transceiver I/Os. In the Quartus II software, the number of user I/Os includes transceiver I/Os." for GPIOs in the Maximum Resource Counts table for Cyclone V E and SE.</li> <li>Added link to Altera Product Selector for each device variant.</li> <li>Updated Embedded Hard IPs for Cyclone V GT devices to indicate Maximum 2 hard PCIe and 2 hard memory controllers.</li> <li>Added leaded package options.</li> <li>Removed the note "The number of PLLs includes general-purpose fractional PLLs and transceiver fractional PLLs." for all PLLs in the Maximum Resource Counts table.</li> <li>Corrected max LVDS counts for transmitter and receiver for Cyclone V E A9 device from 140 to 120.</li> <li>Corrected variable-precision DSP block, 27 x 27 multiplier, 18 x 18 multiplier adder mode and 18 x 18 multiplier adder summed with 36 bit</li> </ul>
<ul> <li>May 2013</li> <li>2013.05.06</li> <li>Added link to the known document issues in the Knowledge Base.</li> <li>Moved all links to the Related Information section of respective topics for easy reference.</li> <li>Corrected the title to the PCIe hard IP topic. Cyclone V devices support only PCIe Gen1 and Gen2.</li> <li>Updated Supporting Feature in Table 1 of Increased bandwidth capacity to '6.144 Gbps'.</li> <li>Updated Description in Table 2 of Low-power high-speed serial interface to '6.144 Gbps'.</li> <li>Updated Description in Table 3 of Cyclone V GT to '6.144 Gbps'.</li> <li>Updated the M386 package to M383 for Figure 1, Figure 2 and Figure 3.</li> <li>Updated LVDS in the Maximum Resource Counts tables to include Transmitter and Receiver values.</li> <li>Updated the m301 and M383 packages from the Cyclone V GX C4 device</li> <li>Updated the GPIO count to '129' for the M301 package of the Cyclone V</li> </ul>			<ul> <li>Corrected 18 x 18 multiplier for Cyclone V SE devices from 116 to 168.</li> <li>Corrected 9 x 9 multiplier for Cyclone V SE devices from 174 to 252.</li> <li>Corrected LVDS transmitter for Cyclone V SE A2 and A4 as well as SX C2 and C4 devices from 31 to 32.</li> <li>Corrected LVDS receiver for Cyclone V SE A2 and A4 as well as SX C2 and C4 devices from 35 to 37.</li> <li>Corrected transceiver speed grade for Cyclone V ST devices ordering code from 4 to 5.</li> <li>Updated the DDR3 SDRAM for the maximum frequency's soft controller and the minimum frequency from 300 to 303 for voltage 1.35V.</li> <li>Added links to Altera's External Memory Spec Estimator tool to the topics listing the external memory interface performance.</li> <li>Corrected XAUI is supported through the soft PCS in the PCS features for Cyclone V.</li> </ul>
Updated 5 Gbps to '6.144 Gbps' forCyclone V GT device.	May 2013	2013.05.06	<ul> <li>Added link to the known document issues in the Knowledge Base.</li> <li>Moved all links to the Related Information section of respective topics for easy reference.</li> <li>Corrected the title to the PCIe hard IP topic. Cyclone V devices support only PCIe Gen1 and Gen2.</li> <li>Updated Supporting Feature in Table 1 of Increased bandwidth capacity to '6.144 Gbps'.</li> <li>Updated Description in Table 2 of Low-power high-speed serial interface to '6.144 Gbps'.</li> <li>Updated Description in Table 3 of Cyclone V GT to '6.144 Gbps'.</li> <li>Updated the M386 package to M383 for Figure 1, Figure 2 and Figure 3.</li> <li>Updated Figure 2 and Figure 3 for Transceiver Count by adding 'F : 4'.</li> <li>Updated the package plan with M383 for the Cyclone V E device.</li> <li>Removed the M301 and M383 packages from the Cyclone V GX C4 device.</li> <li>Updated the GPIO count to '129' for the M301 package of the Cyclone V GX C5 device.</li> </ul>



Date	Version	Changes
		Updated HPS I/O for U484 (19 mm) in Table 11 with '151' for A2, A4, A5 and A6.
		Updated Memory (Kb) for Maximum Resource Counts for Cyclone V SE A4     and A6, SX C4 and C6, ST D6 devices.
		Updated FPGA PLL for Maximum Resource Counts for Cyclone V SE A2, SX C2, devices.
		Removed '36 x 36' from the Variable-Precision DSP Block.
		Updated Variable-precision DSP Blocks and 18 x 18 Multiplier for Maximum Resource Counts for Cyclone V SX C4 device.
		Updated the HPS I/O counts for Cyclone V SE, SX, and ST devices.
		• Updated Figure 7 which shows the I/O vertical migration table.
		Updated Table 17 for Cyclone V SX C4 device.
		Updated Embedded Memory Capacity and Distribution table for Cyclone V SE A4 and A6, SX C4 and C6, ST D6 devices.
		Removed 'Counter reconfiguration' from the PLL Features.
		<ul> <li>Updated Low-Power Serial Transceivers by replacing 5 Gbps with 6.144 Gbps.</li> </ul>
		Removed 'Distributed Memory' symbol.
		• Updated the Capability in Table 22 of Backplane support to '6.144 Gbps'.
		<ul> <li>Updated Capability in Table 22 of Ring oscillator transmit PLLs with 6.144 Gbps.</li> </ul>
		Updated the PCS Support in Table 23 from 5 Gbps to '6 Gbps'.
		• Updated the Data Rates (Gbps) in Table 23 of 3 Gbps and 6 Gbps Basic to '6.144 Gbps'.
		<ul> <li>Updated the Data Rates (Gbps) in Table 23 of CPRI 4.1 to '6.144 Gbps'.</li> <li>Clarified that partial reconfiguration is an advanced feature. Contact Altera for support of the feature.</li> </ul>
December 2012	2012.12.28	Updated the pin counts for the MBGA packages.
		Updated the GPIO and transceiver counts for the MBGA packages.
		• Updated the GPIO counts for the U484 package of the Cyclone V E A9, GX C9, and GT D9 devices.
		<ul> <li>Updated the vertical migration table for vertical migration of the U484 packages.</li> </ul>
		Updated the MLAB supported programmable widths at 32 bits depth.
November 2012	2012.11.19	<ul> <li>Added new MBGA packages and additional U484 packages for Cyclone V E, GX, and GT.</li> </ul>
		• Added ordering code for five-transceiver devices for Cyclone V GT and ST.
		Updated the vertical migration table to add MBGA packages.
		Added performance information for HPS memory controller.
		Removed DDR3U support.
		Updated Cyclone V ST speed grade information.
		<ul> <li>Added information on maximum transceiver channel usage restrictions for PCI Gen2 and CPRI at 4.9152 Gbps transmit jitter compliance.</li> </ul>
		• Added note on the differences between GPIO reported in Overview with User I/O numbers shown in the Quartus II software.
		Updated template.
July 2012	2.1	Added support for PCIe Gen2 x4 lane configuration (PCIe-compatible)
June 2012	2.0	Restructured the document.     Added the "Embedded Memory Conscitut" and "Embedded Memory
		<ul> <li>Added the "Embedded Memory Capacity" and "Embedded Memory Configurations" sections.</li> </ul>
		<ul> <li>Added Table 1, Table 3, Table 16, Table 19, and Table 20.</li> <li>Updated Table 2, Table 4, Table 5, Table 6, Table 7, Table 8, Table 9, Table 10, Table 11, Table 12, Table 12, Table 14, Table 17, and Table 18, Table 19, Table</li></ul>
		10, Table 11, Table 12, Table 13, Table 14, Table 17, and Table 18.